

Silicon Carbide Power Schottky Diode

Features

- 1200 V Schottky rectifier
- 175 °C maximum operating temperature
- Temperature independent switching behavior
- Superior surge current capability
- Positive temperature coefficient of V_F
- Extremely fast switching speeds
- Superior figure of merit Q_C/I_F

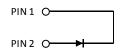
Advantages

- Improved circuit efficiency (Lower overall cost)
- Low switching losses
- Ease of paralleling devices without thermal runaway
- · Smaller heat sink requirements
- Low reverse recovery current
- Low device capacitance
- Low reverse leakage current at operating temperature

Package

RoHS Compliant





DO - 214AA

Applications

- Power Factor Correction (PFC)
- Switched-Mode Power Supply (SMPS)
- Solar Inverters
- Wind Turbine Inverters
- Motor Drives
- Induction Heating
- Uninterruptible Power Supply (UPS)
- High Voltage Multipliers

Maximum Ratings at T_i = 175 °C, unless otherwise specified

Parameter	Symbol	Conditions	Values	Unit	
Repetitive peak reverse voltage	V _{RRM}		1200	V	
Continuous forward current	I _F	T _C ≤ 160 °C	2	А	
RMS forward current	I _{F(RMS)}	T _C ≤ 160 °C	3	А	
Surge non-repetitive forward current, Half Sine		T _C = 25 °C, t _P = 10 ms	18	٨	
Wave	I _{F,SM}	$T_{\rm C}$ = 160 °C, $t_{\rm P}$ = 10 ms	15	A	
Non-repetitive peak forward current	I _{F,max}	T _C = 25 °C, t _P = 10 μs	100	А	
² t value	∫i² dt	T _C = 25 °C, t _P = 10 ms	1.6	A ² s	
tvalue	ji di	$T_{\rm C}$ = 160 °C, $t_{\rm P}$ = 10 ms	1.1	AS	
Power dissipation	P _{tot}	T _C = 25 °C	65	W	
Operating and storage temperature	T _j , T _{stg}		-55 to 175	°C	

Electrical Characteristics at T_j = 175 °C, unless otherwise specified

Parameter	Sympol	Conditions mi		Values		11	
Parameter	Symbol			min.	typ.	max.	Unit
Diode forward voltage	VF	I _F = 2 A, T _j = 2			1.5	1.8	V
Diode loi ward vollage	VF	I _F = 2 A, T _j = 175 °C			2.6	3.0	v
Reverse current	I _R	V _R = 1200 V, T _j = 25 °C		5	50	μA	
		V _R = 1200 V, T _i = 175 °C			10		100
Total capacitive charge	Q _c	V _R = 40			9		
		$dI_F/dt = 200 \text{ A/}\mu \text{s}$ $T_i = 175 \text{ °C}$ V_R	V _R = 960 V		14		nC
Switching time	t _s		V _R = 400 V		< 17		ns
			V _R = 960 V				
Total capacitance		V _R = 1 V, f = 1 MHz, T _j = 25 °C		131		pF	
	С	V _R = 400 V, f = 1 MHz, T _j = 25 °C		12			
		V _R = 1000 V, f = 1 MHz, T _i = 25 °C			8		

Thermal resistance, junction - case	R _{thJC}	2.3	°C/W

Aug 2014

GB02SLT12-214

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1200 V

5 A

9 nC

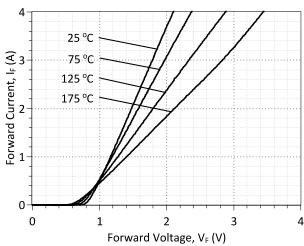
V_{RRM}

Qc

 $I_{F(Tc = 25^{\circ}C)}$

GeneSiC

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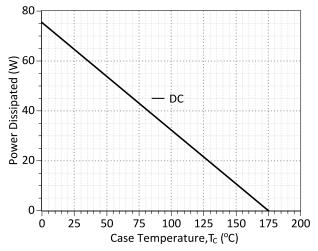


Figure 3: Power Derating Curve

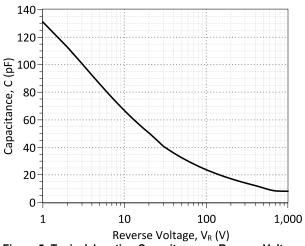


Figure 5: Typical Junction Capacitance vs Reverse Voltage Characteristics

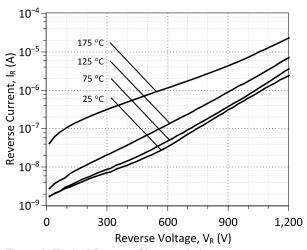
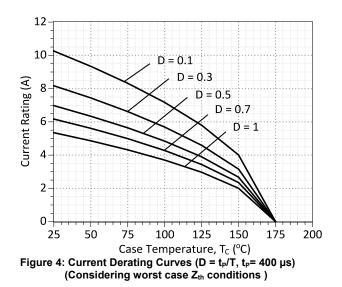
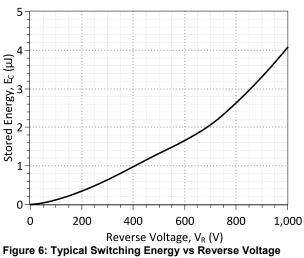


Figure 2: Typical Reverse Characteristics





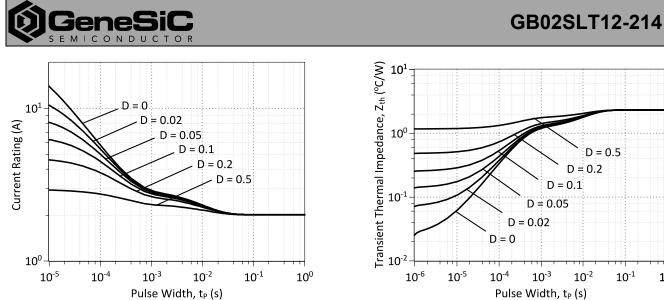


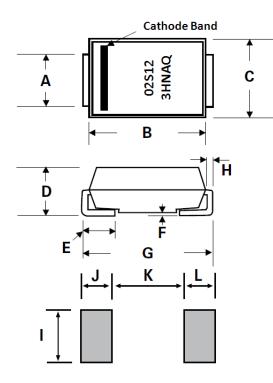
Figure 7: Current vs Pulse Duration Curves at T_c = 160 °C



Package Dimensions:

DO-214AA

PACKAGE OUTLINE



Dimensions	Inches Min Max		Millimeters		
Dimensions			Min	Max	
А	0.077	0.086	1.950	2.200	
В	0.160	0.180	4.060	4.570	
С	0.130	0.155	3.300	3.940	
D	0.084	0.096	2.130	2.440	
E	0.030	0.060	0.760	1.520	
F	-	0.008	-	0.203	
G	0.205	0.220	5.210	5.590	
Н	0.006	0.012	0.152	0.305	
I	0.089	-	2.260	-	
J	0.085	-	2.160	-	
К	-	0.107	-	2.740	
L	0.085	-	2.160	-	

NOTE

CONTROLLED DIMENSION IS INCH. DIMENSION IN BRACKET IS MILLIMETER.
 DIMENSIONS DO NOT INCLUDE END FLASH, MOLD FLASH, MATERIAL PROTRUSIONS

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GB02SLT12-214

Revision History					
Date	Revision	Comments	Supersedes		
2014/08/26	1	Updated Electrical Characteristics			
2013/09/09	0	Initial release			

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SPICE Model Parameters

Copy the following code into a SPICE software program for simulation of the GB02SLT12-214 device.

```
*
     MODEL OF GeneSiC Semiconductor Inc.
*
*
    $Revision: 1.0
                               $
*
    $Date: 09-SEP-2013
                              $
*
*
    GeneSiC Semiconductor Inc.
*
    43670 Trade Center Place Ste. 155
*
    Dulles, VA 20166
*
   http://www.genesicsemi.com/index.php/sic-products/schottky
*
*
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    ALL RIGHTS RESERVED
* These models are provided "AS IS, WHERE IS, AND WITH NO WARRANTY
* OF ANY KIND EITHER EXPRESSED OR IMPLIED, INCLUDING BUT NOT LIMITED
* TO ANY IMPLIED WARRANTIES OF MERCHANTABILITY AND FITNESS FOR A
* PARTICULAR PURPOSE."
* Models accurate up to 2 times rated drain current.
* Start of GB02SLT12-214 SPICE Model
.SUBCKT GB02SLT12 ANODE KATHODE
D1 ANODE KATHODE GB02SLT12
D2 ANODE KATHODE GB02SLT12 PIN
.MODEL GB02SLT12 D
                     RS
TRS2
     2.05E-15
                                 0.282
+ IS
+ TRS1
        0.0054
                                   3E-05
+ N
         1
                        IKF
                                   251
                        XTI
         1.2
+ EG
                                   -1.8
+ CJO
                       VJ
        1.61E-10
                                   0.4508
+ M
         1.586
                        FC
                                   0.5
        1.00E-10
1.00E-03
                       BV
+ TT
                                   1200
+ IBV
                        VPK
                                  1200
+ IAVE
                                  SiC Schottky
         2
                         TYPE
+ MFG GeneSiC_Semi
.MODEL GB02SLT12 PIN D
                       RS
         1.54E-25
                                  0.39
+ IS
        -0.003
+ TRS1
                        Ν
                                   3.941
+ EG
         3.23
                        IKF
                                   19
                        FC
                                   0.5
+ XTI
         0
+ TT
         0
                        BV
                                   1200
+ IBV
+ IAVE
         1.00E-03
                        VPK
                                   1200
          10
                         TYPE
                                  SiC PiN
.ENDS
* End of GB02SLT12-214 SPICE Model
```